NCP553, NCV553

Voltage Regulator - CMOS, Low Iq, NOCAPE

80 mA

This series of fixed output NOCAP linear regulators are designed for handheld communication equipment and portable battery powered applications which require low quiescent. This series features an ultra−low quiescent current of 2.8 μA. Each device contains a voltage reference unit, an error amplifier, a PMOS power transistor, resistors for setting output voltage, current limit, and temperature limit protection circuits.

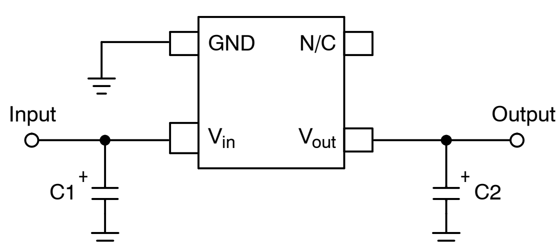
These voltage regulators have been designed to be used with low cost ceramic capacitors. The devices have the ability to operate without an output capacitor. The devices are housed in the micro−miniature SC82−AB surface mount package. Standard voltage versions are 1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.3, and 5.0 V. Other voltages are available in 100 mV steps.

Features

- Low Quiescent Current of 2.8 μA Typical
- Low Output Voltage Option
- Output Voltage Accuracy of 2.0%
- Industrial Temperature Range of −40°C to 85°C (NCV553, T_A = −40°C to +125°C)
- These are Pb−Free Devices
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable

Typical Applications

- Battery Powered Consumer Products
- Hand−Held Instruments
- Camcorders and Cameras



This device contains 32 active transistors

Figure 1. Typical Application Diagram

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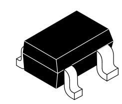
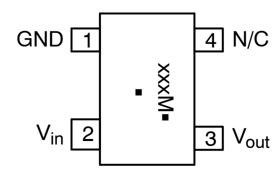


SC82−AB (SC70−4)
SQ SUFFIX
CASE 419C

PIN CONNECTIONS & MARKING DIAGRAMS



(NCP553, NCV553 Top View)

xxx = Device Code
M = Date Code8
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

PIN FUNCTION DESCRIPTION

Pin	Pin Name	Description
1	GND	Power supply ground.
2	Vin	Positive power supply input voltage.
3	Vout	Regulated output voltage.
–	Enable	This input is used to place the device into low−power standby. When this input is pulled low, the device is disabled. If this function is not used, Enable should be connected to Vin.
4	N/C	No internal connection.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	V_{in}	12	V
Output Voltage	V_{out}	−0.3 to V_{in} +0.3	V
Power Dissipation and Thermal Characteristics Power Dissipation Thermal Resistance, Junction−to−Ambient	 P_D $R_{\theta JA}$	 Internally Limited 400	 W °C/W
Operating Junction Temperature	T_J	+125	°C
Operating Ambient Temperature NCP553 NCV553	T_A	 −40 to +85 −40 to +125	°C
Storage Temperature	T_{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. This device series contains ESD protection and exceeds the following tests:
   Human Body Model 2000 V per MIL−STD−883, Method 3015
   Machine Model Method 200 V
2. Latch up capability (85°C) ±200 mA DC with trigger voltage.

ELECTRICAL CHARACTERISTICS

($V_{in} = V_{out(nom.)}$ + 1.0 V, $V_{enable} = V_{in}$, C_{in} = 1.0 μF, C_{out} = 1.0 μF, T_J = 25°C, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Output Voltage (T_A = 25°C, I_{out} = 10 mA) 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.3 V 5.0 V	V_{out}	 1.455 1.746 2.425 2.646 2.744 2.94 3.234 4.900	 1.5 1.8 2.5 2.7 2.8 3.0 3.3 5.0	 1.545 1.854 2.575 2.754 2.856 3.06 3.366 5.100	V
Output Voltage (T_A = −40°C to 85°C, I_{out} = 10 mA) 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.3 V 5.0 V	V_{out}	 1.455 1.746 2.425 2.619 2.716 2.910 3.201 4.900	 1.5 1.8 2.5 2.7 2.8 3.0 3.3 5.0	 1.545 1.854 2.575 2.781 2.884 3.09 3.399 5.100	V
Output Voltage (T_A = −40°C, I_{out} = 10 mA) NCV553 −5.0 V	V_{out}	4.900	5.0	5.100	V
Output Voltage (T_A = +125°C, I_{out} = 10 mA) NCV553 −5.0 V	V_{out}	4.850	5.0	5.150	V
Line Regulation ($V_{in} = V_{out}$ + 1.0 V to 12 V, I_{out} = 10 mA)	Reg_{line}	–	2.0	4.5	mV/V
Load Regulation (I_{out} = 1.0 mA to 80 mA, $V_{in} = V_{out}$ + 2.0 V)	Reg_{load}	–	0.3	0.8	mV/mA
Output Current (V_{out} = (V_{out} at I_{out} = 80 mA) −3.0%) 1.5 V−3.9 V ($V_{in} = V_{out(nom.)}$ + 2.0 V) 4.0 V−5.0 V (V_{in} = 6.0 V)	$I_{o(nom.)}$	 80 80	 180 180	 – –	mA
Dropout Voltage (T_A = −40°C to 125°C, I_{out} = 80 mA, Measured at V_{out} −3.0%) 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.3 V 5.0 V	$V_{in}−V_{out}$	 – – – – – – – –	 1300 1100 800 750 730 680 650 470	 1800 1600 1400 1200 1200 1000 1000 800	mV
Quiescent Current (Enable Input = 0 V) (Enable Input = V_{in}, I_{out} = 1.0 mA to $I_{o(nom.)}$, $V_{in} = V_{out}$ +2.0 V)	I_Q	 – –	 0.1 2.8	 1.0 6.0	μA
Output Short Circuit Current (V_{out} = 0 V) 1.5 V−3.9 V ($V_{in} = V_{out(nom.)}$ + 2.0 V) 4.0 V−5.0 V (V_{in} = 6.0 V)	$I_{out(max)}$	 100 100	 300 300	 450 450	mA
Output Voltage Noise (f = 20 Hz to 100 kHz, I_{out} = 10 mA) (C_{out} = 1.0 μF)	V_n	–	90	–	μVrms
Output Voltage Temperature Coefficient	T_C	–	± 100	–	ppm/°C

3. Maximum package power dissipation limits must be observed.

$$PD = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

4. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

DEFINITIONS

Load Regulation

The change in output voltage for a change in output current at a constant temperature.

Dropout Voltage

The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 3.0% below its nominal. The junction temperature, load current, and minimum input supply requirements affect the dropout level.

Maximum Power Dissipation

The maximum total dissipation for which the regulator will operate within its specifications.

Quiescent Current

The quiescent current is the current which flows through the ground when the LDO operates without a load on its output: internal IC operation, bias, etc. When the LDO becomes loaded, this term is called the Ground current. It is actually the difference between the input current (measured through the LDO input pin) and the output current.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse technique such that the average chip temperature is not significantly affected.

Line Transient Response

Typical over and undershoot response when input voltage is excited with a given slope.

Thermal Protection

Internal thermal shutdown circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated at typically 160°C, the regulator turns off. This feature is provided to prevent failures from accidental overheating.

Maximum Package Power Dissipation

The maximum power package dissipation is the power dissipation level at which the junction temperature reaches its maximum operating value, i.e. 125°C. Depending on the ambient power dissipation and thus the maximum available output current.

TYPICAL CHARACTERISTICS

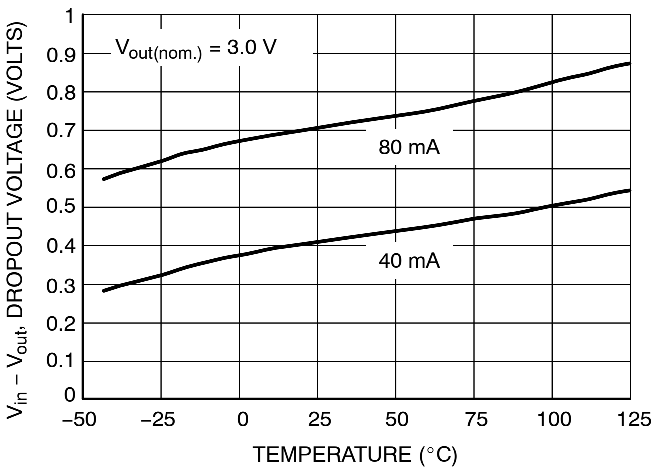


Figure 2. Dropout Voltage versus Temperature

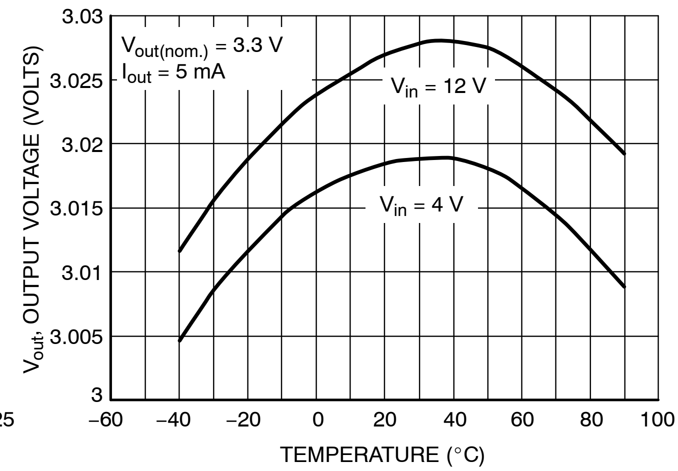


Figure 3. Output Voltage versus Temperature

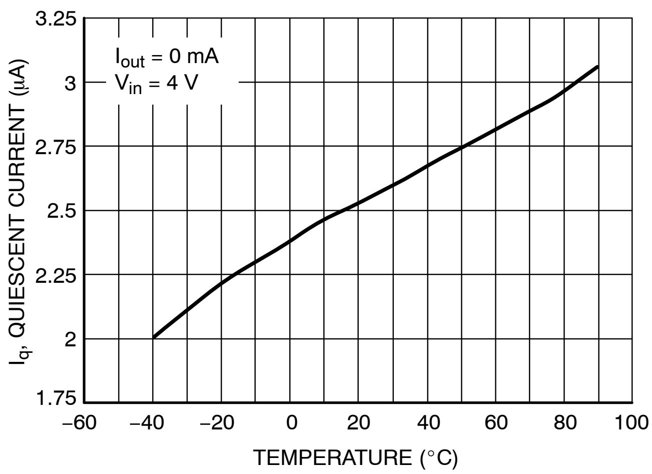


Figure 4. Quiescent Current versus Temperature

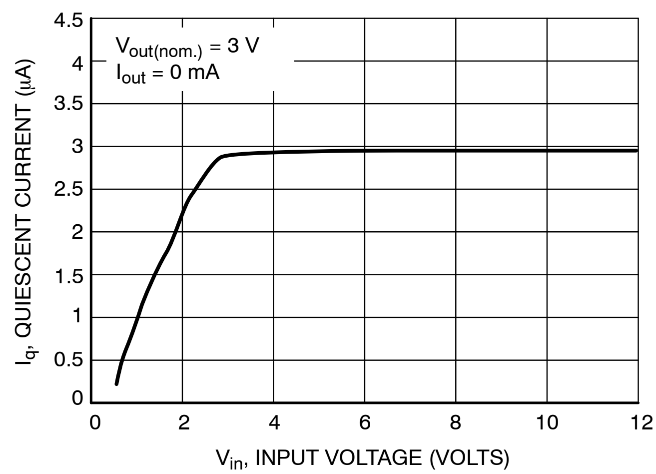


Figure 5. Quiescent Current versus Input Voltage

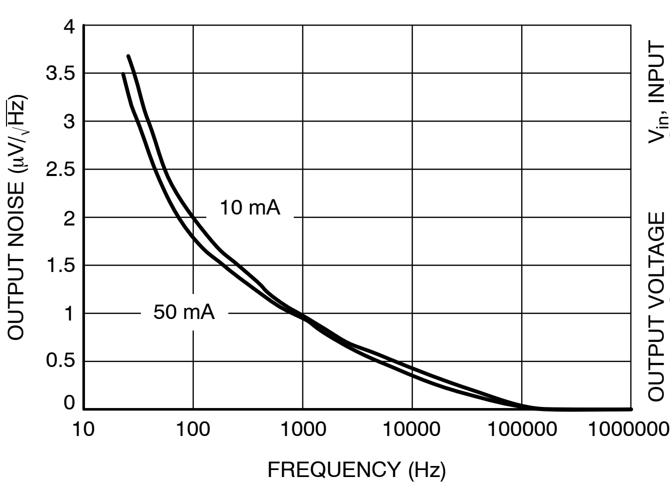


Figure 6. Output Noise Density

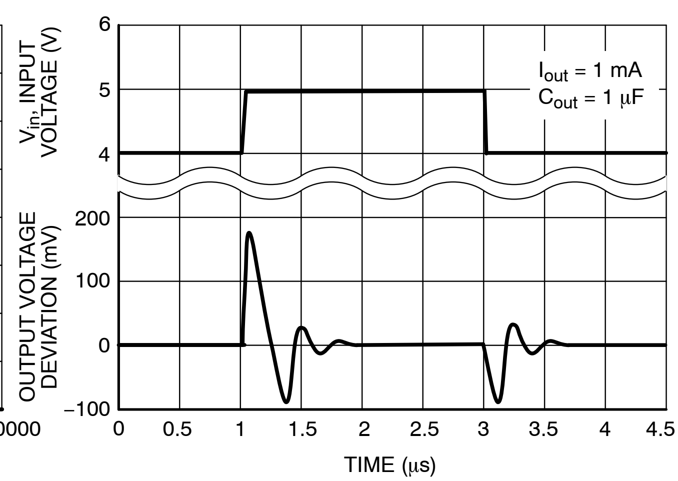


Figure 7. Line Transient Response

TYPICAL CHARACTERISTICS

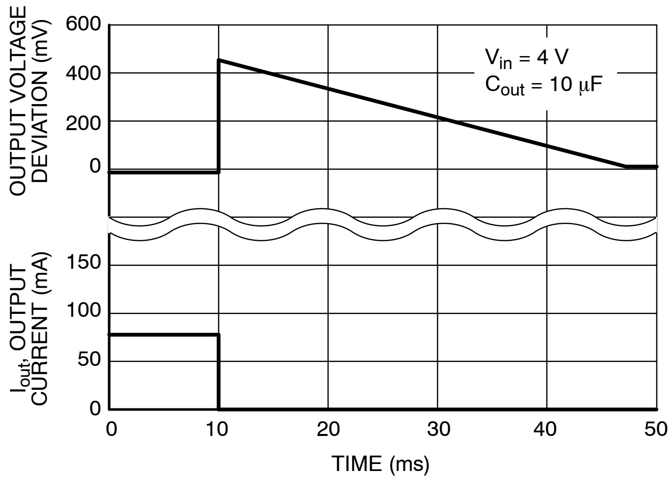


Figure 8. Load Transient Response

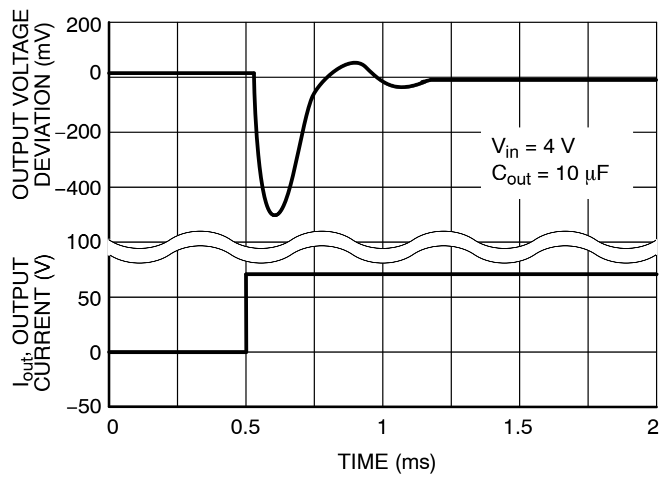


Figure 9. Load Transient Response

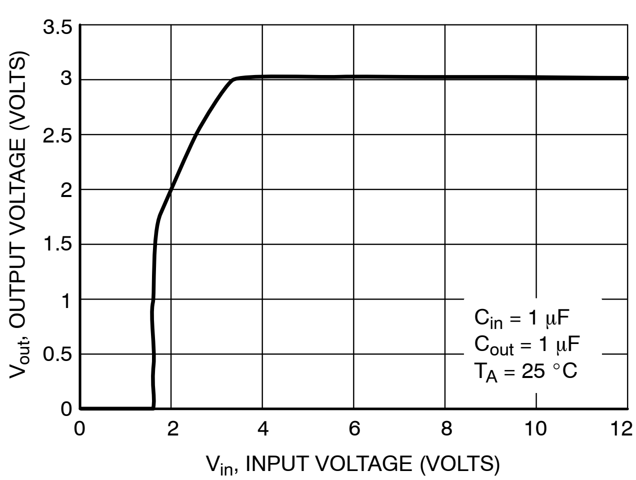


Figure 10. Output Voltage versus Input Voltage

APPLICATIONS INFORMATION

A typical application circuit for the NCP553 series is shown in Figure 1, front page.

Input Decoupling (C1)

A 1.0 μF capacitor either ceramic or tantalum is recommended and should be connected close to the package. Higher values and lower ESR will improve the overall line transient response. If large line or load transients are not expected, then it is possible to operate the regulator without the use of a capacitor.
TDK capacitor: C2012X5R1C105K, or C1608X5R1A105K

Output Decoupling (C2)

The NCP553 are very stable regulators and do not require any specific Equivalent Series Resistance (ESR) or a minimum output current. If load transients are not to be expected, then it is possible for the regulator to operate with no output capacitor. Otherwise, capacitors exhibiting ESRs ranging from a few mΩ up to 10 Ω can thus safely be used. The minimum decoupling value is 0.1 μF and can be augmented to fulfill stringent load transient requirements. The regulator accepts ceramic chip capacitors as well as tantalum devices. Larger values improve noise rejection and load regulation transient response.
TDK capacitor: C2012X5R1C105K, C1608X5R1A105K, or C3216X7R1C105K

Hints

Please be sure the Vin and GND lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or cause the regulator to malfunction.

Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

Thermal

As power across the NCP553 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material and also the ambient temperature effect the rate of temperature rise for the part. This is stating that when the devices have good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

The maximum dissipation the package can handle is given by:

$$PD = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

If junction temperature is not allowed above the maximum 125°C, then the NCP553 can dissipate up to 250 mW @ 25°C.

The power dissipated by the NCP553 can be calculated from the following equation:

$$P_{tot} = \left[V_{in} * I_{gnd}(I_{out})\right] + [V_{in} - V_{out}] * I_{out}$$

or

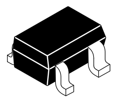
$$V_{inMAX} = \frac{P_{tot} + V_{out} * I_{out}}{I_{gnd} + I_{out}}$$

If an 80 mA output current is needed then the ground current from the data sheet is 2.8 μA. For an NCP553 (3.0 V), the maximum input voltage will then be 6.12 V.

ORDERING INFORMATION

Device	Nominal Output Voltage (Note 5)	Marking	Package	Shipping†
NCP553SQ15T1G	1.5	LBE	SC82−AB (SC70−4) (Pb−Free)	3000 Units/ 8″ Tape & Reel
NCP553SQ18T1G	1.8	LBF		
NCP553SQ25T1G	2.5	LBG		
NCP553SQ27T1G	2.7	LBH		
NCP553SQ28T1G	2.8	LBI		
NCP553SQ30T1G	3.0	LBJ		
NCP553SQ33T1G	3.3	LBK		
NCP553SQ50T1G	5.0	LBL		
NCV553SQ15T1G*	1.5	AAF		
NCV553SQ30T1G*	3.0	LBJ		
NCV553SQ50T1G*	5.0	LFT		

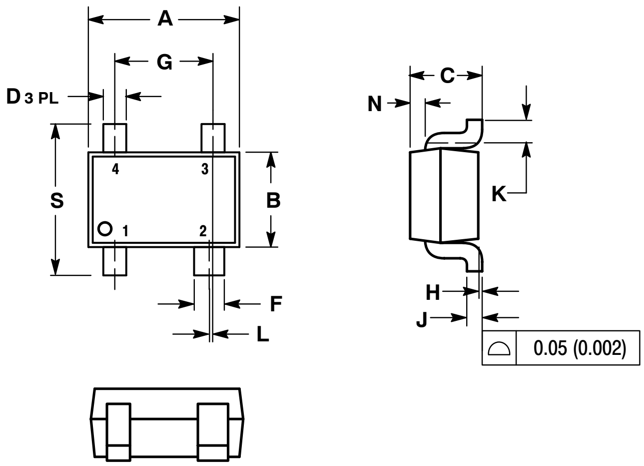
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
5. Additional voltages in 100 mV steps are available upon request by contacting your ON Semiconductor representative.



SC−82AB
CASE 419C−02
ISSUE F

DATE 22 JUN 2012

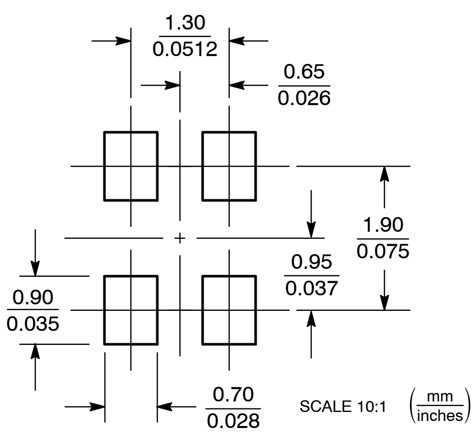
SCALE 4:1



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. 419C−01 OBSOLETE. NEW STANDARD IS 419C−02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

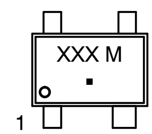
	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	1.80	2.20	0.071	0.087
B	1.15	1.35	0.045	0.053
C	0.80	1.10	0.031	0.043
D	0.20	0.40	0.008	0.016
F	0.30	0.50	0.012	0.020
G	1.10	1.50	0.043	0.059
H	0.00	0.10	0.000	0.004
J	0.10	0.26	0.004	0.010
K	0.10	−−−	0.004	−−−
L	0.05 BSC		0.002 BSC	
N	0.20 REF		0.008 REF	
S	1.80	2.40	0.07	0.09

SOLDERING FOOTPRINT*



*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code
M = Month Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

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DESCRIPTION:	**SC−82AB**	**PAGE 1 OF 1**

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